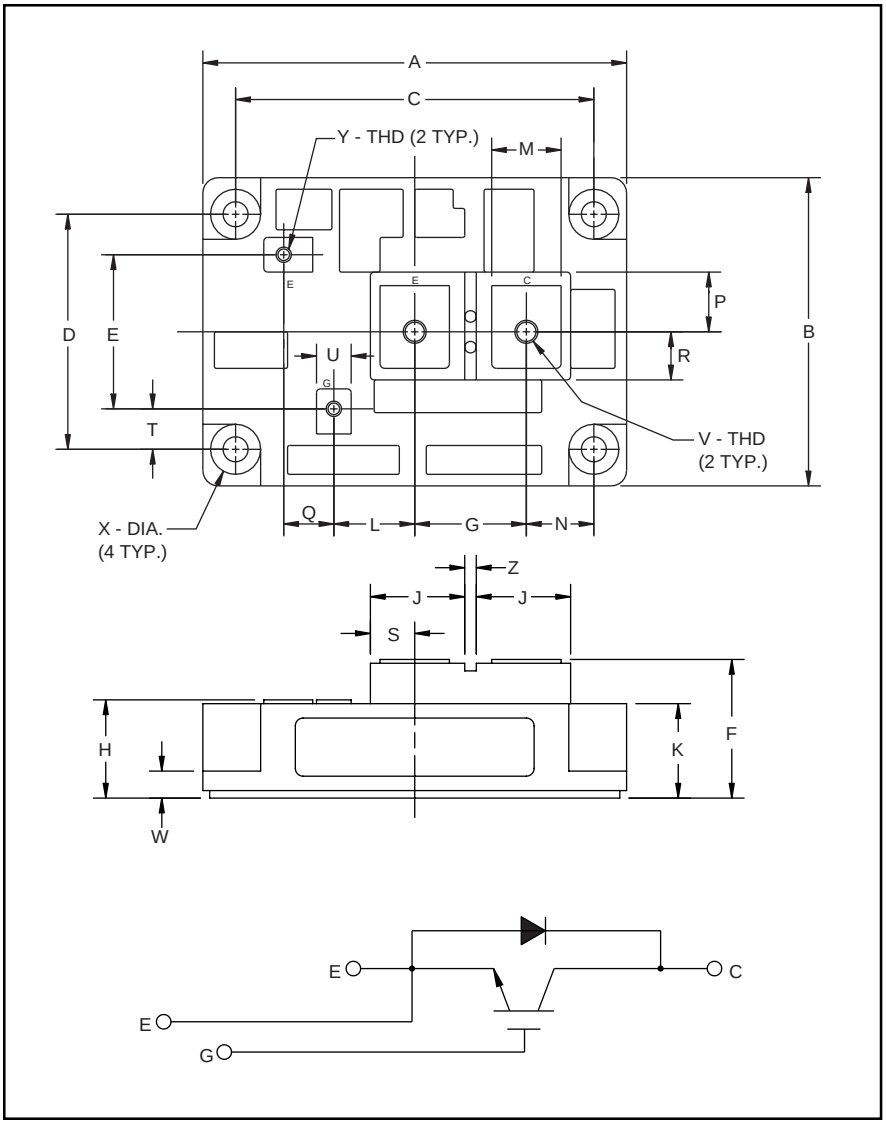
Powerex, Inc., 200 Hillis Street, Youngwood, Pennsylvania 15697-1800 (724) 925-7272

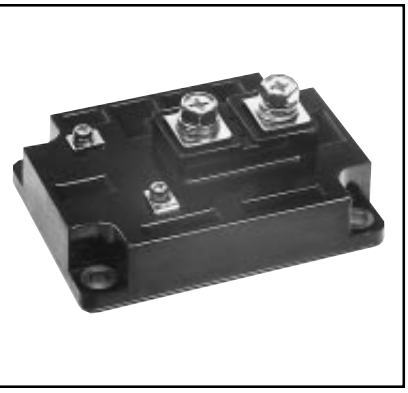
Single IGBTMOD™ H-Series Module
600 Amperes/1200 Volts



Outline Drawing and Circuit Diagram

Dimensions	Inches	Millimeters
A	4.33	110.0
B	3.15	80.0
C	3.66±0.008	93.0±0.25
D	2.44±0.008	62.0±0.25
E	1.57	40.0
F	1.42 Max.	36.0 Max.
G	1.14	29.0
H	1.00 Max.	25.5 Max.
J	0.96	25.0
K	0.94	24.5
L	0.83	21.0
M	0.71	18.0

Dimensions	Inches	Millimeters
N	0.69	17.5
P	0.61	15.5
Q	0.51	13.0
R	0.49	12.5
S	0.45	11.5
T	0.43	11.0
U	0.35	9.0
V	M8 Metric	M8
W	0.28	7.0
X	0.256 Dia.	Dia. 6.50
Y	M4 Metric	M4
Z	0.12	3.04



Description:
Powerex IGBTMOD™ Modules are designed for use in switching applications. Each module consists of one IGBT Transistor in a single configuration with a reverse-connected super-fast recovery free-wheel diode. All components and interconnects are isolated from the heat sinking baseplate, offering simplified system assembly and thermal management.

Features:
- ☐ Low Drive Power
- ☐ Low $V_{CE(sat)}$
- ☐ Discrete Super-Fast Recovery (135ns) Free-Wheel Diode
- ☐ High Frequency Operation (20-25kHz)
- ☐ Isolated Baseplate for Easy Heat Sinking

Applications:
- ☐ AC Motor Control
- ☐ Motion/Servo Control
- ☐ UPS
- ☐ Welding Power Supplies
- ☐ Laser Power Supplies

Ordering Information:
Example: Select the complete part module number you desire from the table below -i.e. CM600HA-24H is a 1200V (V_{CES}), 600 Ampere Single IGBTMOD™ Power Module.

Type	Current Rating Amperes	V_{CES} Volts (x 50)
CM	600	24

CM600HA-24H
Single IGBTMOD™ H-Series Module
600 Amperes/1200 Volts

Absolute Maximum Ratings, T_j = 25 °C unless otherwise specified

Ratings	Symbol	CM600HA-24H	Units
Junction Temperature	T_j	–40 to 150	°C
Storage Temperature	T_{stg}	–40 to 125	°C
Collector-Emitter Voltage (G-E SHORT)	V_{CES}	1200	Volts
Gate-Emitter Voltage	V_{GES}	±20	Volts
Collector Current	I_C	600	Amperes
Peak Collector Current	I_{CM}	1200*	Amperes
Diode Forward Current	I_F	600	Amperes
Diode Forward Surge Current	I_{FM}	1200*	Amperes
Power Dissipation	P_d	4100	Watts
Max. Mounting Torque M8 Terminal Screws	–	95	in-lb
Max. Mounting Torque M6 Mounting Screws	–	26	in-lb
Module Weight (Typical)	–	560	Grams
V Isolation	V_{RMS}	2500	Volts

* Pulse width and repetition rate should be such that device junction temperature does not exceed the device rating.

Static Electrical Characteristics, T_j = 25 °C unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Collector-Cutoff Current	I_{CES}	$V_{CE} = V_{CES}$, V_{GE} = 0V	–	–	2.0	mA
Gate Leakage Current	I_{GES}	$V_{GE} = V_{GES}$, V_{CE} = 0V	–	–	0.5	μA
Gate-Emitter Threshold Voltage	$V_{GE(th)}$	I_C = 60mA, V_{CE} = 10V	4.5	6.0	7.5	Volts
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	I_C = 600A, V_{GE} = 15V	–	2.5	3.4**	Volts
		I_C = 600A, V_{GE} = 15V, T_j = 150°C	–	2.25	–	Volts
Total Gate Charge	Q_G	V_{CC} = 600V, I_C = 600A, V_{GS} = 15V	–	3000	–	nC
Diode Forward Voltage	V_{FM}	I_E = 600A, V_{GS} = 0V	–	–	3.5	Volts

** Pulse width and repetition rate should be such that device junction temperature rise is negligible.

Dynamic Electrical Characteristics, T_j = 25 °C unless otherwise specified

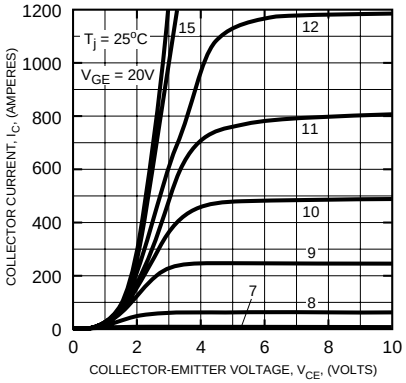
Characteristics		Symbol	Test Conditions	Min.	Typ.	Max.	Units
Input Capacitance		C_{ies}	V_{GE} = 0V, V_{CE} = 10V, f = 1MHz	–	–	120	nF
Output Capacitance		C_{oes}		–	–	42	nF
Reverse Transfer Capacitance		C_{res}		–	–	24	nF
Resistive	Turn-on Delay Time	$t_{d(on)}$	V_{CC} = 600V, I_C = 600A, $V_{GE1} = V_{GE2}$ = 15V, R_G = 2.1Ω	–	–	300	ns
Load	Rise Time	t_r		–	–	700	ns
Switching	Turn-off Delay Time	$t_{d(off)}$		–	–	450	ns
Times	Fall Time	t_f		–	–	350	ns
Diode Reverse Recovery Time		t_{rr}	I_E = 600A, di_E/dt = –1200A/μs	–	–	250	ns
Diode Reverse Recovery Charge		Q_{rr}	I_E = 600A, di_E/dt = –1200A/μs	–	4.46	–	μC

Thermal and Mechanical Characteristics, T_j = 25 °C unless otherwise specified

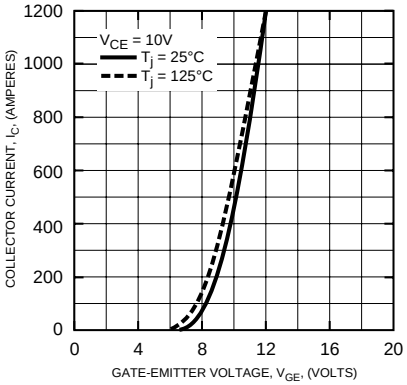
Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal Resistance, Junction to Case	$R_{th(j-c)}$	Per IGBT	–	–	0.035	°C/W
Thermal Resistance, Junction to Case	$R_{th(j-c)}$	Per FWDi	–	–	0.06	°C/W
Contact Thermal Resistance	$R_{th(c-f)}$	Per Module, Thermal Grease Applied	–	–	0.035	°C/W

CM600HA-24H
Single IGBTMOD™ H-Series Module
600 Amperes/1200 Volts

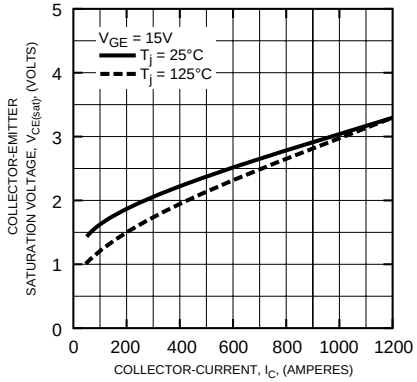
OUTPUT CHARACTERISTICS (TYPICAL)



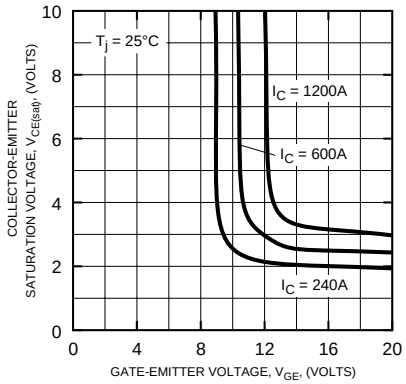
TRANSFER CHARACTERISTICS (TYPICAL)



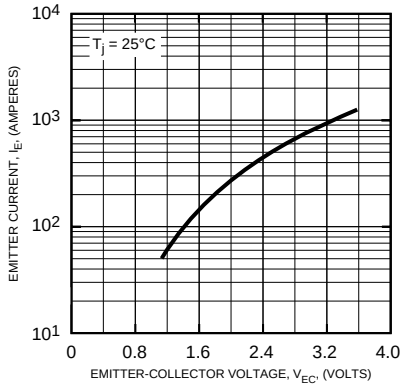
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



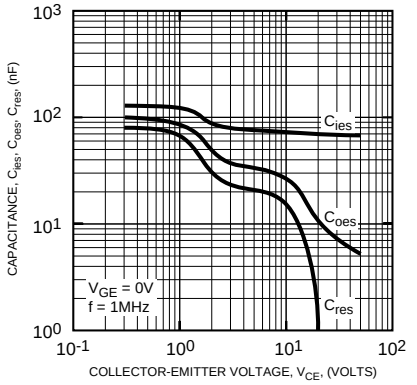
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



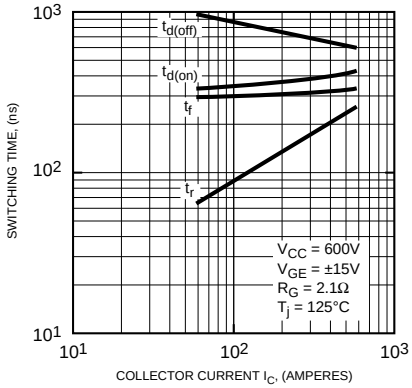
FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)



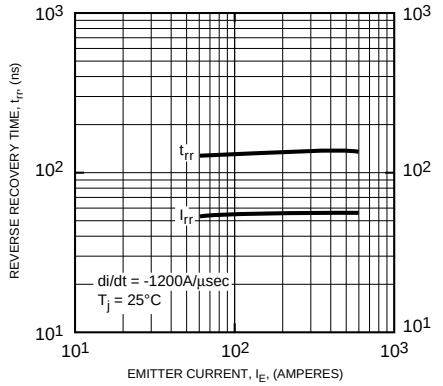
CAPACITANCE VS. V_{CE} (TYPICAL)



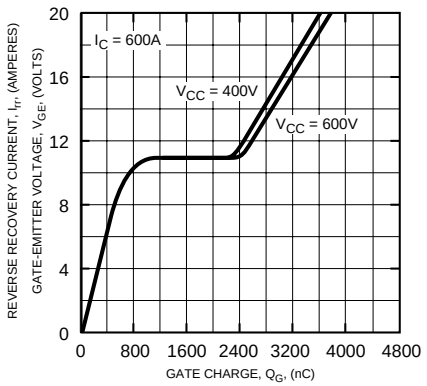
HALF-BRIDGE SWITCHING CHARACTERISTICS (TYPICAL)



REVERSE RECOVERY CHARACTERISTICS (TYPICAL)

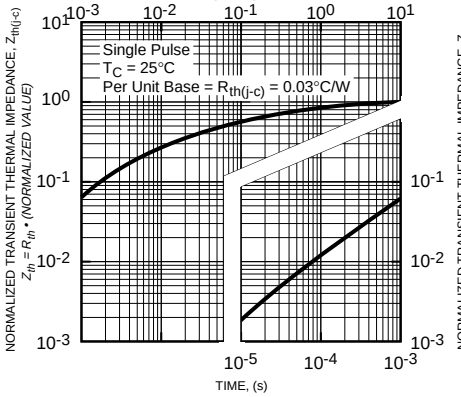


GATE CHARGE, V_{GE}



CM600HA-24H
Single IGBTMOD™ H-Series Module
600 Amperes/1200 Volts

TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS (IGBT)



TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS (FWDi)

